

**Features:**

- Molded package for superior heat dissipation
- Typical inductance < 5nH
- RoHS compliant, REACH compliant, lead free, and halogen free
- Package size 2512 is AEC-Q200 compliant



Electrical Specifications			
Type/Code	Power Rating (W)	TCR (ppm/°C)	Ohmic Range (Ω) and Tolerance
			1%, 5%
CSM0603	0.33	± 70	0.01
CSM2512	3	± 50	0.001 - 0.1

Max. Working Voltage =  $(P \cdot R)^{1/2}$

P = Rated Power (W)

R = Resistance Value (Ω)

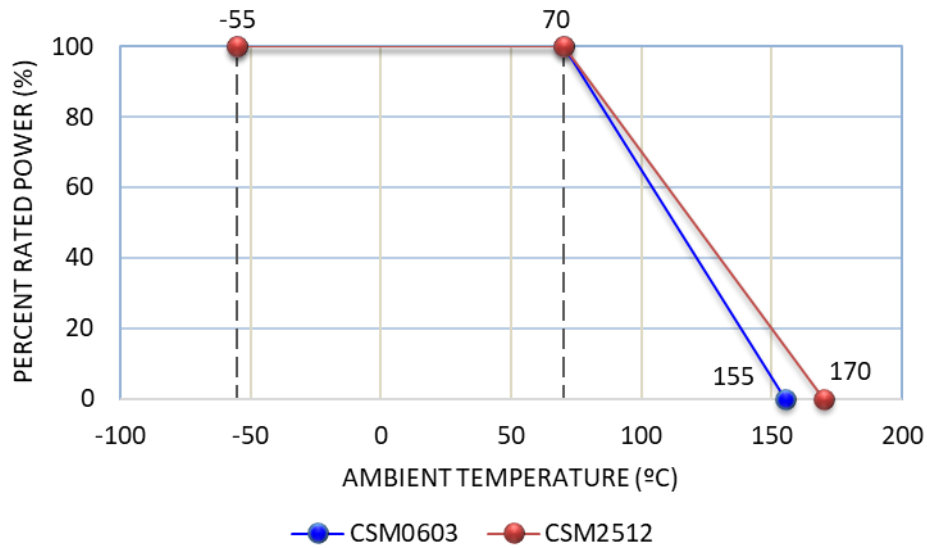
Mechanical Specifications					
Type/Code	L	W	H	d	Unit
CSM0603	0.063 ± 0.004	0.031 ± 0.004	0.012 ± 0.004	0.012 ± 0.004	inches
	1.60 ± 0.10	0.80 ± 0.10	0.30 ± 0.10	0.30 ± 0.10	mm
CSM2512 (0.001 Ω - 0.004 Ω)	0.252 ± 0.008	0.126 ± 0.008	0.035 ± 0.008	0.079 ± 0.008	inches
	6.40 ± 0.20	3.20 ± 0.20	0.90 ± 0.20	2.00 ± 0.20	mm
CSM2512 (> 0.004 Ω - 0.1 Ω)	0.252 ± 0.008	0.126 ± 0.008	0.035 ± 0.008	0.035 ± 0.008	inches
	6.40 ± 0.20	3.20 ± 0.20	0.90 ± 0.20	0.90 ± 0.20	mm

Performance Characteristics		
Test Item	Test Specification	Test Condition
Temperature Coefficient of Resistance	CSM2512 ± 50 ppm/°C CSM0603 ± 70 ppm/°C	+25°C ~ +125°C
Load Life	± 1%	1000 hours at rated power, 70°C, 1.5 hours ON, 0.5 hours OFF
Short Time Overload	± 0.5%	5 X rated power for 5 seconds
Moisture No Load	± 0.5%	85°C, 85% R.H., 1000 hours
Temperature Cycling	< ± 0.5%	1000 cycles (-55°C to 125°C) Measurement at 24 hours after test conclusion JESD22 Method JA-104
Resistance to Soldering Heat	± 0.5%	260 ± 5°C for 20 ± 1 seconds
Solderability	At least 95% of surface area of electrode must be covered with new solder	245 ± 5°C for 2 ± 0.5 seconds

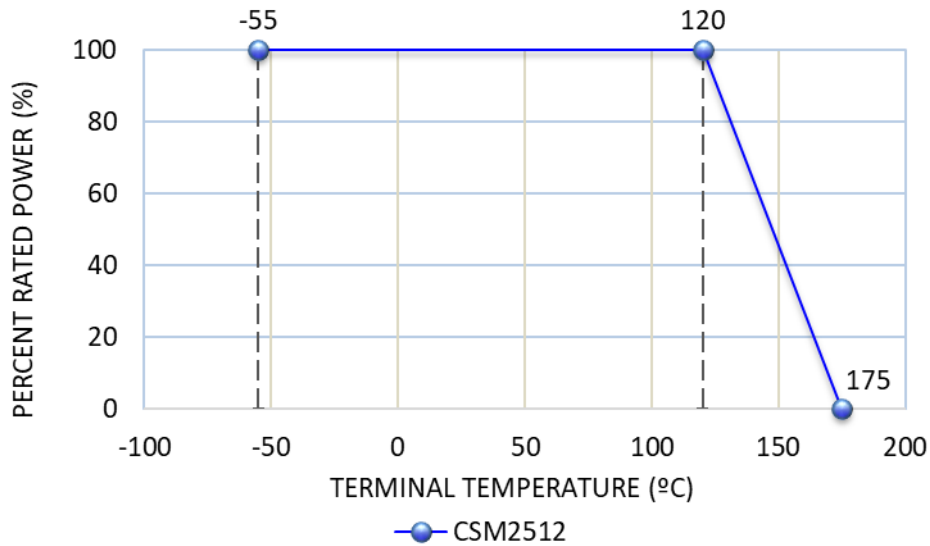
Performance Characteristics (cont.)		
Test Item	Test Specification	Test Condition
High Temperature Exposure	± 0.5%	170°C for 1000 hours
Low Temperature Storage	± 0.5%	-55°C for 1000 hours
Substrate Bending	± 1%	Bending width 2 mm
Insulation Resistance	> 100MΩ	100VDC for 1 minute

Recommended storage conditions: Temperature 5°C ~ 35°C; R.H. 40% ~ 75%  
Operating temperature range for CSM0603 is -55°C to +155°C and for CSM2512 is -55°C to +170°C

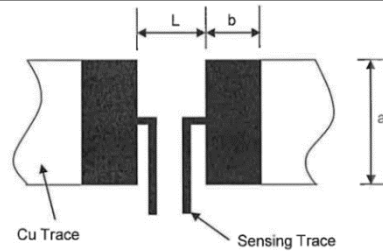
Power Derating Curve:



Terminal Temperature:



**Recommended Pad Layout**



Type/Code	a	b	L	Unit
CSM0603	0.039	0.028	0.035	inches
	1.00	0.70	0.90	mm
CSM2512 ( $\leq 0.004 \Omega$ )	0.157	0.122	0.051	inches
	4.00	3.10	1.30	mm
CSM2512 ( $> 0.004 \Omega$ )	0.157	0.083	0.161	inches
	4.00	2.10	4.10	mm

**Recommended Solder Profile**

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with “\*”.

**100% Matte Tin / RoHS Compliant Terminations**

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration.  
Maximum number of reflow cycles: 3.

**Wave Soldering**

Description	Maximum	Recommended	Minimum
Preheat Time	80 seconds	70 seconds	60 seconds
Temperature Diff.	140°C	120°C	100°C
Solder Temp.	260°C	250°C	240°C
Dwell Time at Max.	10 seconds	5 seconds	*
Ramp DN (°C/sec)	N/A	N/A	N/A

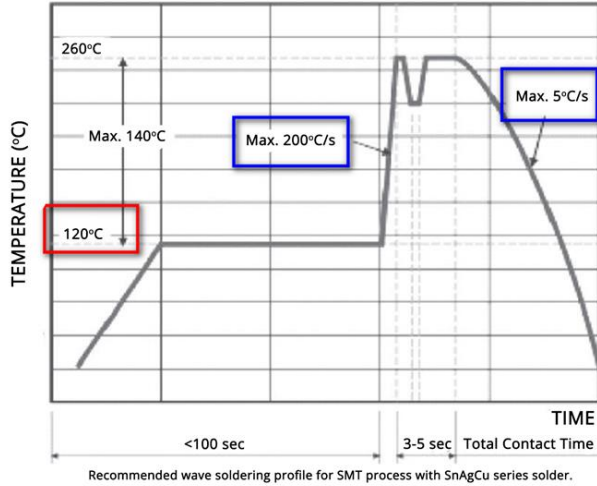
Temperature Diff. = Difference between final preheat stage and soldering stage.

**Convection IR Reflow**

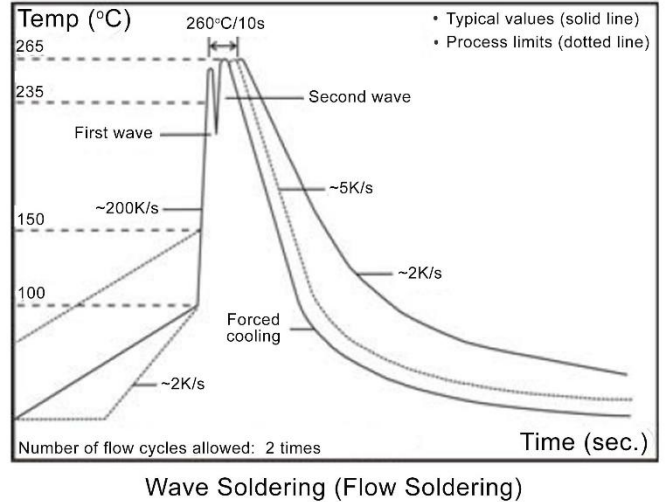
Description	Maximum	Recommended	Minimum
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds
Solder Temp.	260°C	245°C	*
Dwell Time at Max.	30 seconds	15 seconds	10 seconds
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*

**Wave Soldering Profile**

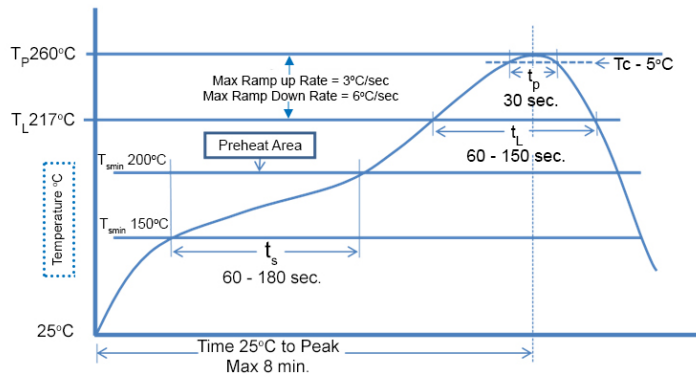
**CSM0603**



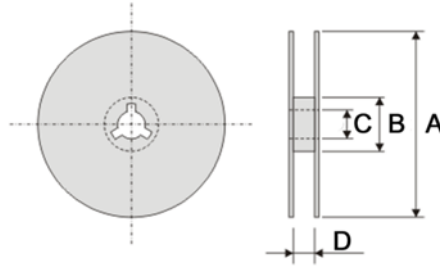
**CSM2512**



**Recommended Lead Free Resistor Reflow Profile**

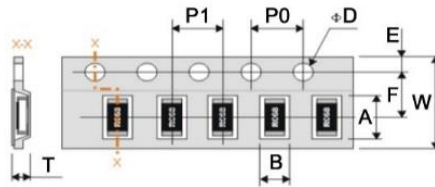


**Reel Specifications**

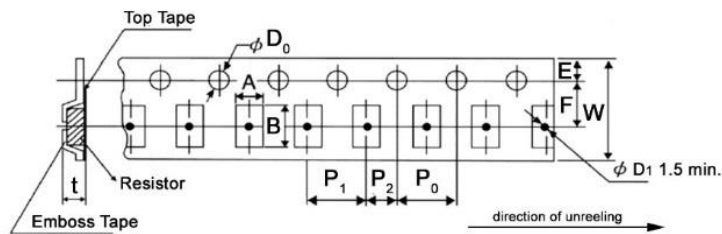


Type/Code	A	B	C	D	Unit
CSM0603	7.087 ± 0.059	2.362 ± 0.039	0.512 ± 0.008	0.354 ± 0.039	inches
	180.00 ± 1.50	60.00 ± 1.00	13.00 ± 0.20	9.00 ± 1.00	mm
CSM2512	7.087 ± 0.059	2.362 ± 0.039	0.512 ± 0.039	0.512 ± 0.039	inches
	180.00 ± 1.50	60.00 ± 1.00	13.00 ± 1.00	13.00 ± 1.00	mm

**Taping Specifications**



Type/Code	A	B	W	F	E	Unit
CSM0603 Paper Tape	0.075 ± 0.008	0.045 ± 0.006	0.315 ± 0.008	0.138 ± 0.002	0.069 ± 0.004	inches
	1.90 ± 0.20	1.15 ± 0.15	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10	mm
	P1	P0	∅D	T	Unit	
	0.157 ± 0.004	0.157 ± 0.004	0.059 +0.004/-0	0.031 max.	inches	
	4.00 ± 0.10	4.00 ± 0.10	1.50 +0.10/-0	0.80 max.	mm	



Type/Code	A	B	W	F	E	Unit
CSM2512 Plastic Tape	0.142 ± 0.008	0.272 ± 0.008	0.472 ± 0.008	0.217 ± 0.002	0.069 ± 0.004	inches
	3.60 ± 0.20	6.90 ± 0.20	12.00 ± 0.20	5.50 ± 0.05	1.75 ± 0.10	mm
	P1	P2	P0	D0	t	Unit
	0.157 ± 0.004	0.079 ± 0.002	0.157 ± 0.002	0.059 +0.004 / -0	0.047 ± 0.006	inches
	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.05	1.50 +0.10 / -0	1.20 ± 0.15	mm

## RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union’s directive regarding “Restrictions on Hazardous Substances” (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

RoHS Compliance Status						
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)
CSM	Molded Metal Alloy Current Sensing Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always

## “Conflict Metals” Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the “conflict region” of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

## Compliance to “REACH”

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, “The Registration, Evaluation, Authorization and Restriction of Chemicals”, otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

## Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

## How to Order

